

### FEATURES

Dual Serial Input, Voltage Output DACs  
 Single +5 Volt Supply  
 0.005% THD+N  
 Low Power –50 mW  
 115 dB Channel Separation  
 Operates at 8× Oversampling  
 16-Pin Plastic DIP or SOIC Package

### APPLICATIONS

Multimedia Workstations  
 PC Audio Add-In Boards  
 Portable CD and DAT Players  
 Automotive CD and DAT Players  
 Noise Cancellation

### PRODUCT DESCRIPTION

The AD1866 is a complete dual 16-bit DAC offering excellent performance while requiring a single +5 V power supply. It is fabricated on Analog Devices' ABCMOS wafer fabrication process. The monolithic chip includes CMOS logic elements, bipolar and MOS linear elements and laser trimmed, thin-film resistor elements. Careful design and layout techniques have resulted in low distortion, low noise, high channel separation and low power dissipation.

The DACs on the AD1866 chip employ a partially segmented architecture. The first three MSBs of each DAC are segmented into 7 elements. The 13 LSBs are produced using standard R-2R techniques. The segments and R-2R resistors are laser trimmed to provide extremely low total harmonic distortion. The AD1866 requires no deglitcher or trimming circuitry.

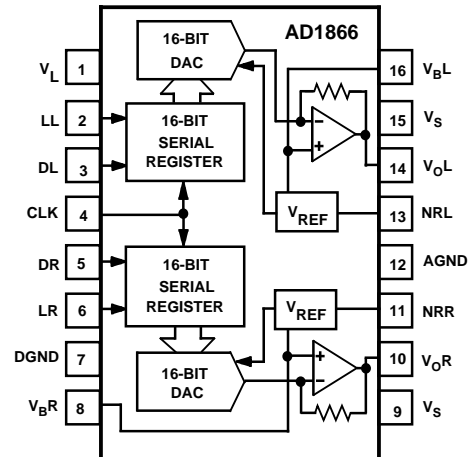
Each DAC is equipped with a high performance output amplifier. These amplifiers achieve fast settling and high slew rate, producing  $\pm 1$  V signals at load currents up to  $\pm 1$  mA. The buffered output signal range is 1.5 V to 3.5 V. The 2.5 V reference voltages eliminate the need for "false ground" networks.

A versatile digital interface allows the AD1866 to be directly connected to all digital filter chips. Fast CMOS logic elements allow for an input clock rate of up to 16 MHz. This allows for operation at 2×, 4×, 8×, or 16× the sampling frequency (where  $F_S = 44.1$  kHz) for each channel. The digital input pins of the AD1866 are TTL and +5 V CMOS compatible.

### REV. 0

Information furnished by Analog Devices is believed to be accurate and reliable. However, no responsibility is assumed by Analog Devices for its use, nor for any infringements of patents or other rights of third parties which may result from its use. No license is granted by implication or otherwise under any patent or patent rights of Analog Devices.

### FUNCTIONAL BLOCK DIAGRAM



The AD1866 operates on +5 V power supplies. The digital supply,  $V_L$ , can be separated from the analog supply,  $V_S$ , for reduced digital feedthrough. Separate analog and digital ground pins are also provided. In systems employing a single +5 volt power supply,  $V_L$  and  $V_S$  should be connected together. In battery operated systems, operation will continue even with reduced supply voltage. Typically, the AD1866 dissipates 50 mW.

The AD1866 is packaged in either a 16-pin plastic DIP or a 16-pin plastic SOIC package. Operation is guaranteed over the temperature range of  $-35^\circ\text{C}$  to  $+85^\circ\text{C}$  and over the voltage supply range of 4.75 V to 5.25 V.

### PRODUCT HIGHLIGHTS

1. Single supply operation @ +5 V.
2. 50 mW power dissipation.
3. THD+N is 0.005% (typical).
4. Signal-to-Noise Ratio is 95 dB (typical).
5. 115 dB channel separation (typical).
6. Compatible with all digital filter chips.
7. 16-pin DIP and 16-pin SOIC packages.
8. No deglitcher required.
9. No external adjustments required.

# AD1866—SPECIFICATIONS (T<sub>A</sub> = +25°C and +5 V supplies unless otherwise noted)

	Min	Typ	Max	Unit
RESOLUTION		16		Bits
DIGITAL INPUTS	<b>2.4</b>		<b>0.8</b>	V
$V_{IH}$				V
$V_{IL}$				μA
$I_{IH}, V_{IH} = V_L$		1.0		μA
$I_{IL}, V_{IL} = DGND$		-10.0		MHz
Maximum Clock Input Frequency	<b>13.5</b>			
ACCURACY				
Gain Error		±3		% of FSR
Gain Matching		±3		% of FSR
Midscale Error		±30		mV
Midscale Error Matching		±10		mV
Gain Linearity Error		±3		dB
DRIFT (0°C to +70°C)				
Gain Drift		±100		ppm/°C
Midscale Drift		-130		μV/°C
TOTAL HARMONIC DISTORTION + NOISE				
0 dB, 990.5 Hz AD1866N		0.005	<b>0.01</b>	%
AD1866R		0.005	<b>0.01</b>	%
-20 dB, 990.5 Hz AD1866N		0.02		%
AD1866R		0.02		%
-60 dB, 990.5 Hz AD1866N		2.0		%
AD1866R		2.0		%
CHANNEL SEPARATION (1 kHz, 0 dB)	<b>108</b>	115		dB
SIGNAL-TO-NOISE RATIO (With A-Weight Filter)		95		dB
D-RANGE (With A-Weight Filter)		90		dB
OUTPUT				
Voltage Output Pins ( $V_{OL}, V_{OR}$ )				
Output Range (±3%)		±1		V
Output Impedance		0.1		Ω
Load Current		±1		mA
Bias Voltage Pins ( $V_{BL}, V_{BR}$ )				
Output Range		+2.5		V
Output Impedance		350		Ω
POWER SUPPLY				
Specification, $V_L$ and $V_S$	<b>4.75</b>	5	<b>5.25</b>	V
Operation, $V_L$ and $V_S$	<b>3.5</b>		<b>5.25</b>	V
+I, $V_L$ and $V_S = 5$ V		10	<b>14</b>	mA
POWER DISSIPATION		50	70	mW
TEMPERATURE RANGE				
Operation	-35		<b>85</b>	°C
Storage	-60		<b>100</b>	°C

Specifications subject to change without notice.

Specifications in **boldface** are tested on all production units at final electrical

# Typical Performance—AD1866



Figure 1. THD+N vs. Frequency



Figure 2. Channel Separation vs. Frequency

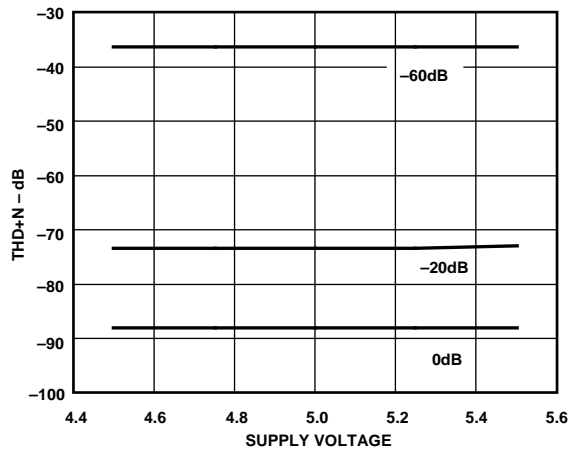


Figure 3. THD+N vs. Supply Voltage

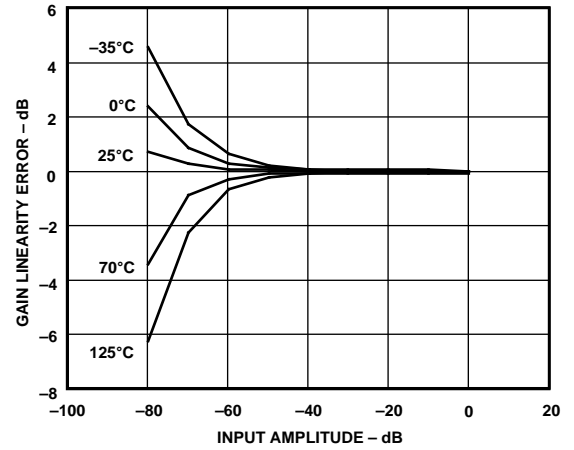


Figure 4. Gain Linearity Error vs. Input Amplitude

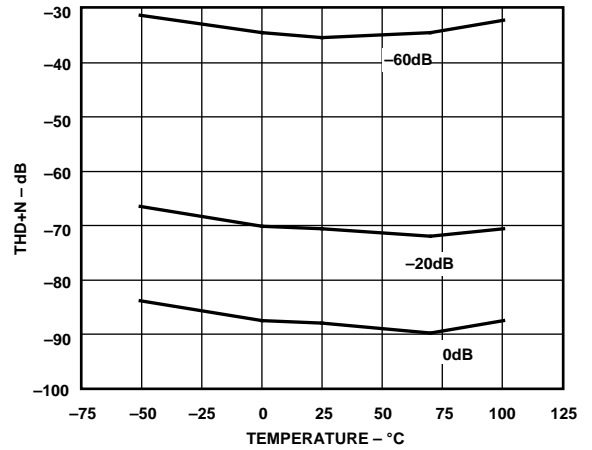


Figure 5. THD+N vs. Temperature

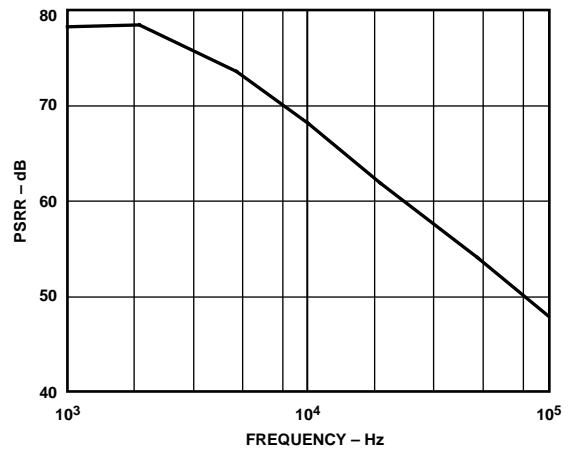


Figure 6. Power Supply Rejection Ratio vs. Frequency (Supply Modulation Amplitude at 500 mV p-p)

# AD1866

## ABSOLUTE MAXIMUM RATINGS\*

$V_L$ to DGND	0 V to 6 V
$V_S$ to AGND	0 V to 6 V
AGND to DGND	$\pm 0.3$ V
Digital Inputs to DGND	-0.3 V to $V_L$
Soldering (10 sec)	+300°C

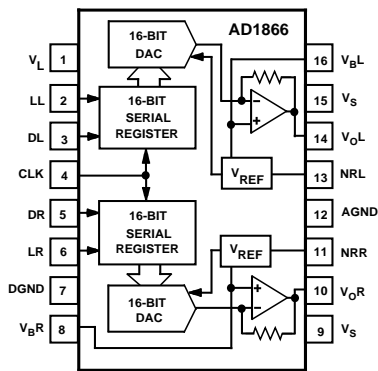
\*Stresses greater than those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

## CAUTION

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although the AD1866 features proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.



## PIN CONFIGURATION



## PIN DESIGNATIONS

Pin	Mnemonic	Description
1	$V_L$	Digital Supply (+5 V)
2	LL	Left Channel Latch Enable Pin
3	DL	Left Channel Data Input Pin
4	CLK	Clock Input Pin
5	DR	Right Channel Data Input Pin
6	LR	Right Channel Latch Enable Pin
7	DGND	Digital Common Pin
8	$V_{B-R}$	Right Channel Bias Pin
9	$V_S$	Analog Supply (+5 V)
10	$V_{O-R}$	Right Channel Output Pin
11	NRR	Right Channel Noise Reduction Pin
12	AGND	Analog Common Pin
13	NRL	Left Channel Noise Reduction Pin
14	$V_{O-L}$	Left Channel Output Pin
15	$V_S$	Analog Supply (+5 V)
16	$V_{B-L}$	Left Channel Bias Pin

## ORDERING GUIDE

Model	Temperature Range	Package Description	Package Option
AD1866N	-35°C to +85°C	Plastic DIP	N-16
AD1866R	-35°C to +85°C	SOIC	R-16
AD1866R-REEL	-35°C to +85°C	SOIC	R-16



# AD1866—Analog Circuit Considerations

## GROUNDING RECOMMENDATIONS

The AD1866 has two ground pins, designated as AGND (Pin 12) and DGND (Pin 7). The analog ground, AGND, serves as the “high quality” reference ground for analog signals and as a return path for the supply current from the analog portion of the device. The system analog common should be located as close as possible to Pin 12 to minimize any voltage drop which may develop between these two points, although the internal circuit is designed to minimize signal dependence of the analog return current.

The digital ground, DGND, returns ground current from the digital portion of the device. This pin should be connected to the digital common node in the system. As shown in Figure 7, the analog and digital grounds should be joined at one point in a system. When these two grounds are connected such as at the power supply ground, care should be taken to minimize the voltage difference between the DGND and AGND pins in order to ensure the specified performance.

## POWER SUPPLIES AND DECOUPLING

The AD1866 has three power supply input pins.  $V_S$  (Pins 9 and 15) provide the supply voltages which operate the analog portion of the device including the 16-bit DACs, the voltage references, and the output amplifiers. The  $V_S$  supplies are designed to operate from a +5 V supply. These pins should be decoupled to the analog ground using a 0.1  $\mu\text{F}$  capacitor. Good engineering practice suggests that the bypass capacitor be placed as close as possible to the package pins. This minimizes the inherent inductive effects of printed circuit board traces.

$V_L$  (Pin 1) operates the digital portions of the chip including the input shift registers and the input latching circuitry.  $V_L$  is also designed to operate from a +5 V supply. This pin should be bypassed to digital common using a 0.1  $\mu\text{F}$  capacitor, again placed as close as possible to the package pins. Figure 7 illustrates the correct connection of the digital and analog supply bypass capacitors.

An important feature of the AD1866 audio DAC is its ability to operate at diminished power supply voltages. This feature is very important in portable battery operated systems. As the batteries discharge, the supply voltage drops. Unlike any other audio DAC, the AD1866 can continue to function at supply voltages as low as 3.5 V. Because of its unique design, the power requirements of the AD1866 diminish as the battery voltage drops, further extending the operating time of the system.

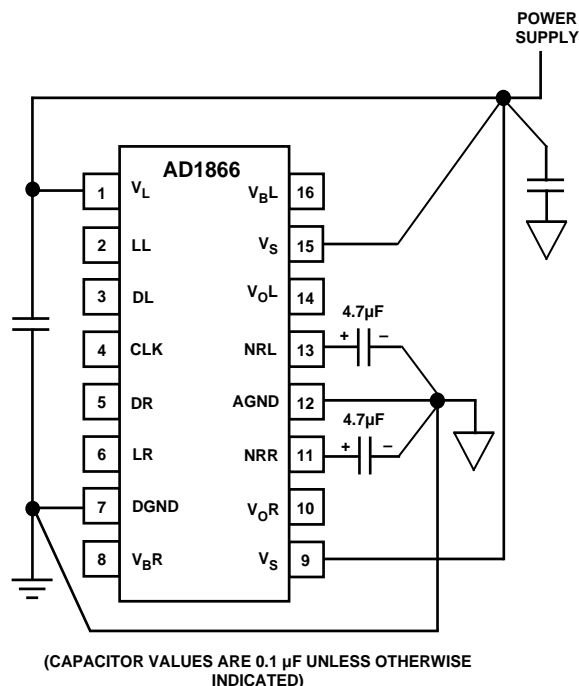


Figure 7. Recommended Circuit Schematic

## NOISE REDUCTION CAPACITORS

The AD1866 has two noise reduction pins, designated as NRL (Pin 13) and NRR (Pin 11). In order to meet specifications, it is required that external noise reduction capacitors be connected from these pins to AGND to reduce the output noise contributed by the voltage reference circuitry. As shown in Figure 7, each of these pins should be bypassed to AGND with a 4.7  $\mu\text{F}$  or larger capacitor. The connections between the capacitors, package pins and AGND should be as short as possible to achieve the lowest noise.

## USING $V_{B_L}$ AND $V_{B_R}$

The AD1866 has two bias voltage reference pins, designated as  $V_{B_R}$  (Pin 8) and  $V_{B_L}$  (Pin 16). Each of these pins supplies a dc reference voltage equal to the center of the output voltage swing. These bias voltages replace “false ground” networks previously required in single supply audio systems. At the same time, they allow dc coupled systems, improving audio performance.

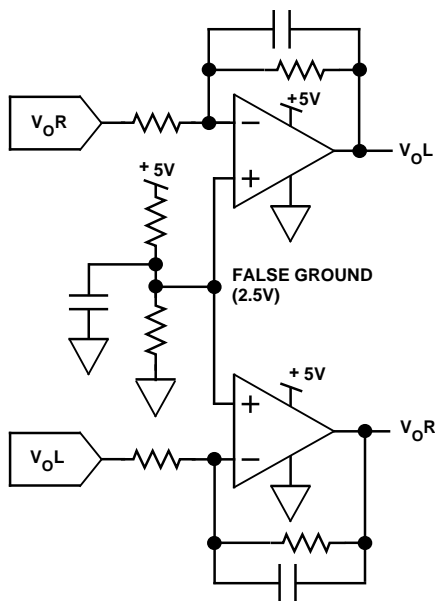


Figure 8a. Schematic Using False Ground

Figure 8a illustrates the traditional approach used to generate false ground voltages in single supply audio systems. This circuit requires additional power and circuit board space.

The AD1866 eliminates the need for “false ground” circuitry.  $V_{BR}$  and  $V_{BL}$  generate the required bias voltages previously generated by the “false ground.” As shown in Figure 8b,  $V_{BR}$  and  $V_{BL}$  may be used as the reference point in each output channel. This permits a dc coupled output signal path. This eliminates ac coupling capacitors and improves low frequency performance. It should be noted that these bias outputs have relatively high output impedance and will not drive output currents larger than 100  $\mu$ A without degrading the specified performance.

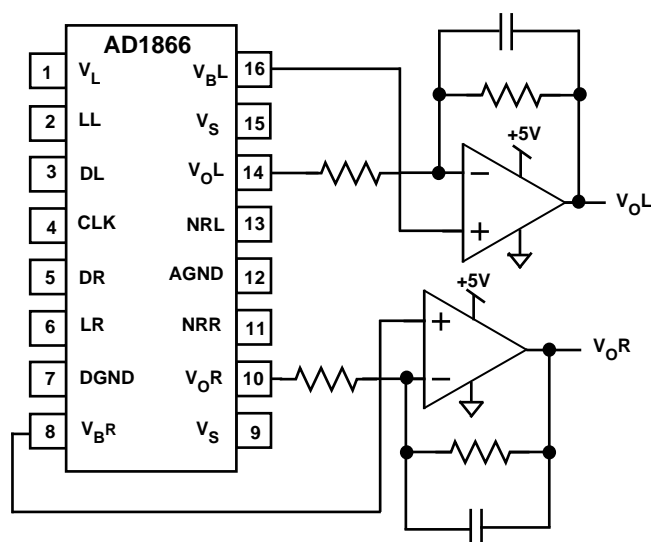


Figure 8b. Circuitry Using Voltage Biases

### DISTORTION PERFORMANCE AND TESTING

The THD+N figure of an audio DAC represents the amount of undesirable signal produced during reconstruction and playback of an audio waveform. Therefore, the THD+N specification provides a direct measure to classify and choose an audio DAC for a desired level of performance. Figure 1 illustrates the typical THD+N versus frequency performance of the AD1866. It is evident that the THD+N performance of the AD1866 remains stable at all three amplitude levels through a wide range of frequencies. A load impedance of at least 2 k $\Omega$  is recommended for best THD+N performance.

Analog Devices tests all AD1866s on the basis of THD+N performance. During the distortion test, a high speed digital pattern generator transmits digital data to each channel of the device under test. Sixteen-bit data is latched into the DAC at 352.8 kHz ( $8 \times F_S$ ). The test input code is a digitally encoded 990.5 Hz sine wave with 0 dB, -20 dB, and -60 dB amplitudes. A 4096 point FFT calculates total harmonic distortion + noise, signal-to-noise ratio, and D-range. No deglitchers or external adjustments are used.

# AD1866–Digital Circuit Considerations



Figure 9. AD1866 Control Signals

## INPUT DATA

The digital input port of the AD1866 employs five signals: Data Left (DL), Data Right (DR), Latch Left (LL), Latch Right (LR), and Clock (CLK). DL and DR are the serial inputs for the left and right DACs, respectively. Input data bits are clocked into the input register on the rising edge of CLK. The falling edges of LL and LR cause the last 16 bits which were clocked into the serial registers to be shifted into the DACs, thereby updating the respective DAC outputs. For systems using only a single latch signal, LL and LR may be connected together. For systems using only one DATA signal, DR and DL may be connected together. Data is transmitted to the AD1866 in a bit stream composed of 16-bit words with a serial, two's complement, MSB first format. Left and right channels share the Clock (CLK) signal.

Figure 9 illustrates the general signal requirements for data transfer for the AD1866.

## TIMING

Figure 10 illustrates the specific timing requirements that must be met in order for the data transfer to be accomplished properly. The input pins of the AD1866 are both TTL and +5 V CMOS compatible.

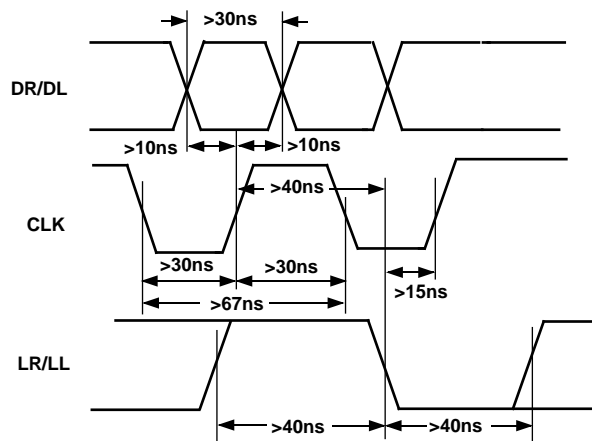


Figure 10. AD1866 Input Signal Timing

The maximum clock rate of the AD1866 is specified to be at least 13.5 MHz. This clock rate allows data transfer rates of 2 $\times$ , 4 $\times$ , 8 $\times$ , and 16 $\times$   $F_S$  (where  $F_S$  equals 44.1 kHz). The applications section of this data sheet contains additional guidelines for using the AD1866.





# AD1866



Figure 12. AD1866 with NPC SM5813 Digital Filter

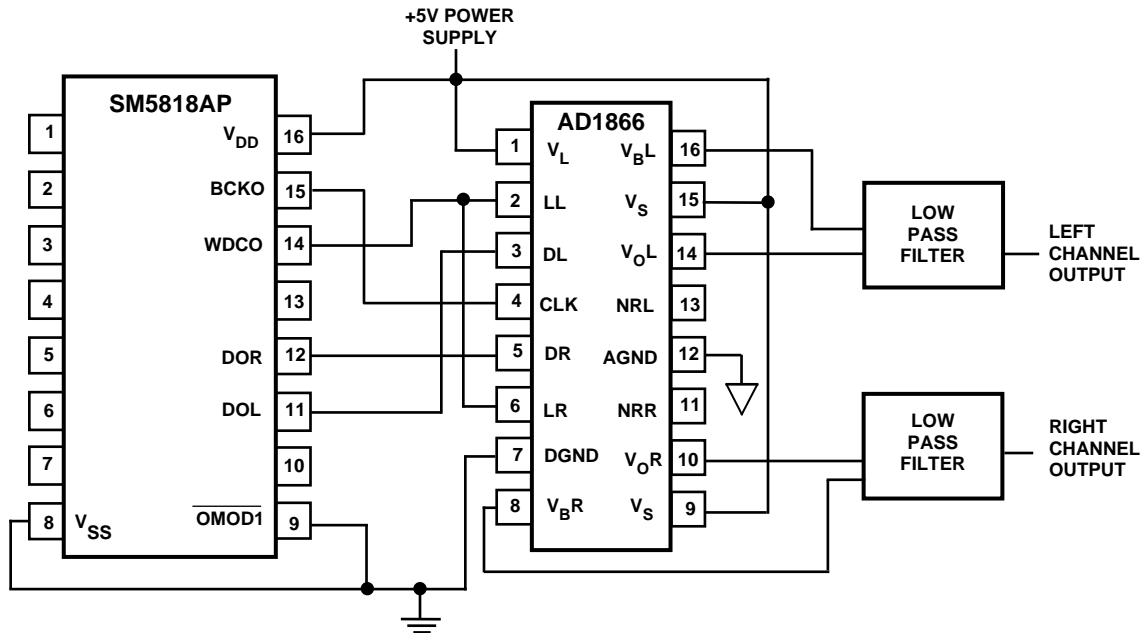


Figure 13. AD1866 with NPC SM5818AP Digital Filter



**OUTLINE DIMENSIONS**  
 Dimensions shown in inches and (mm).

**Plastic DIP (N) Package**



**Plastic SOIC (R) Package**

